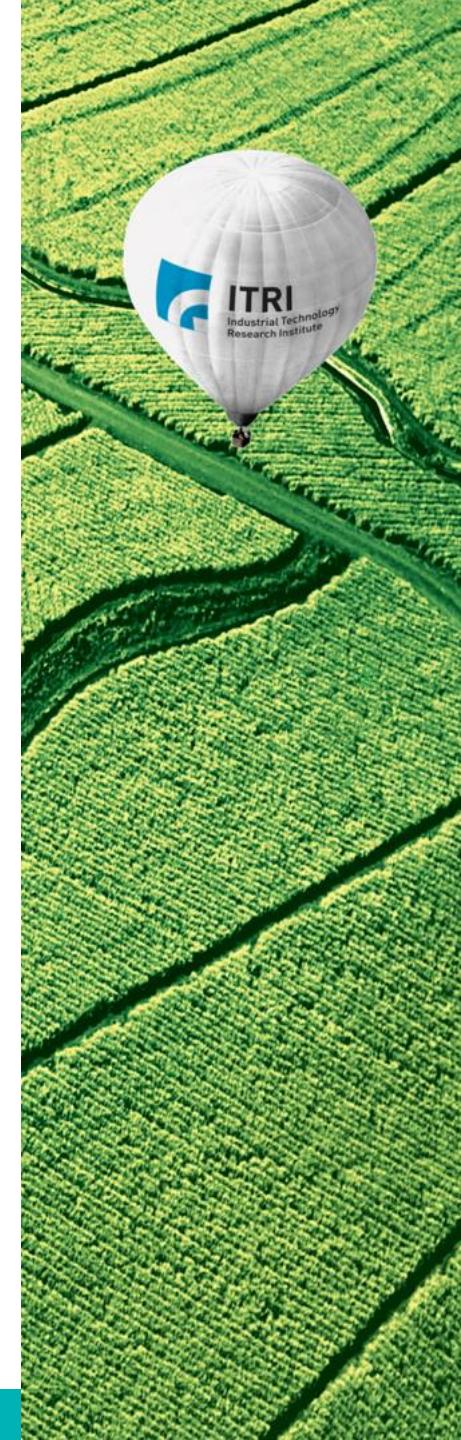


# Nanoparticle Measurements and Applications in Semiconductor Manufacturing

Wei-En Fu, Division Director

Measurement Standards and Precision Instrumentation Division  
CMS/ITRI

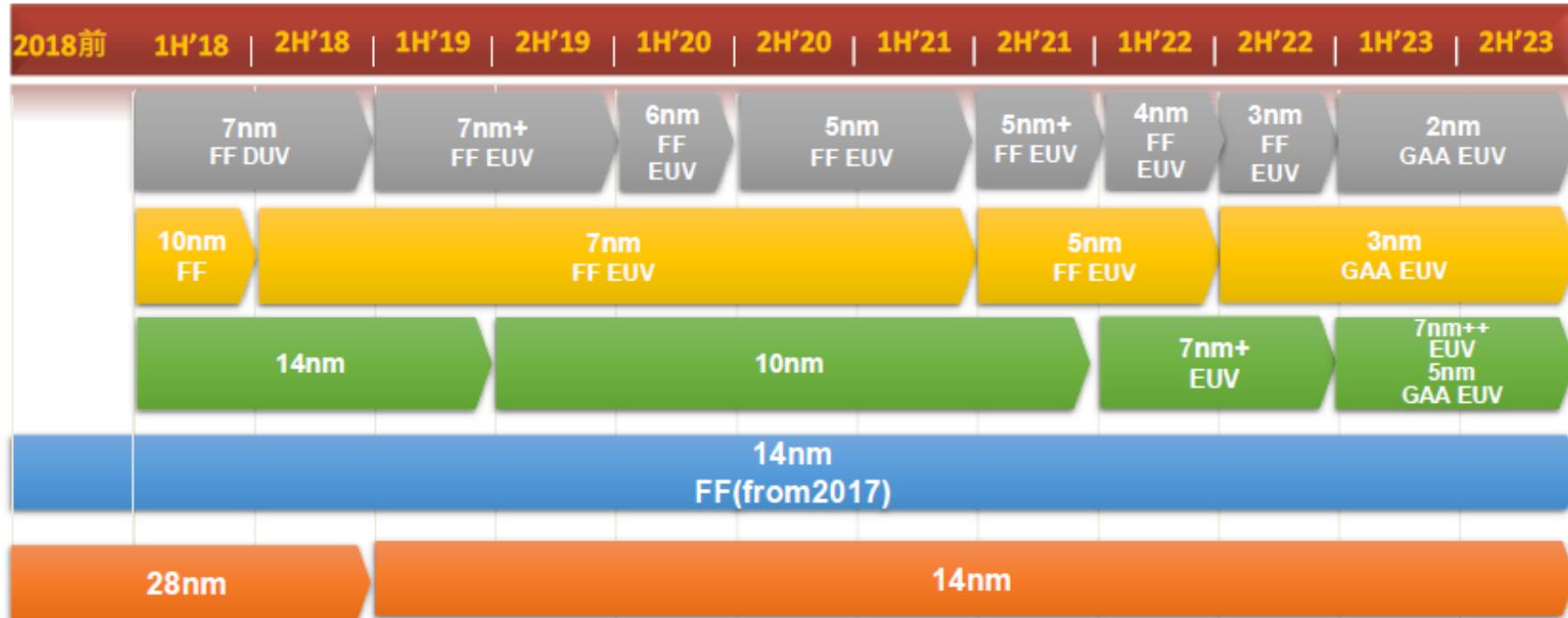
2022.10.26



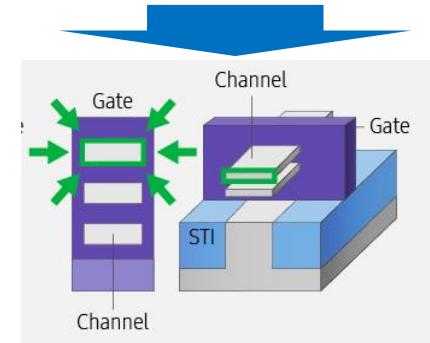
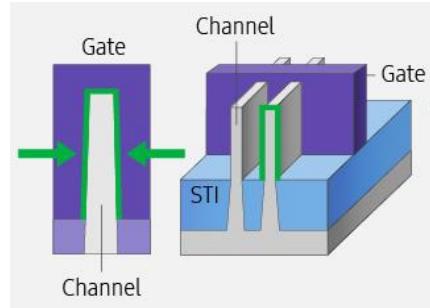
# Outline

- Demands for Nanoparticle Metrology in Semiconductor Manufacturing
- Nanoparticle Metrology Development
  - Measurement technology
  - SEMI Taiwan- WG for Purity And Particle Analysis for Semiconductor Raw Materials
- Summary

# More ‘Moore’ Continues to Drive ...



Gate-All-Around, GAA  
FinFET, FF

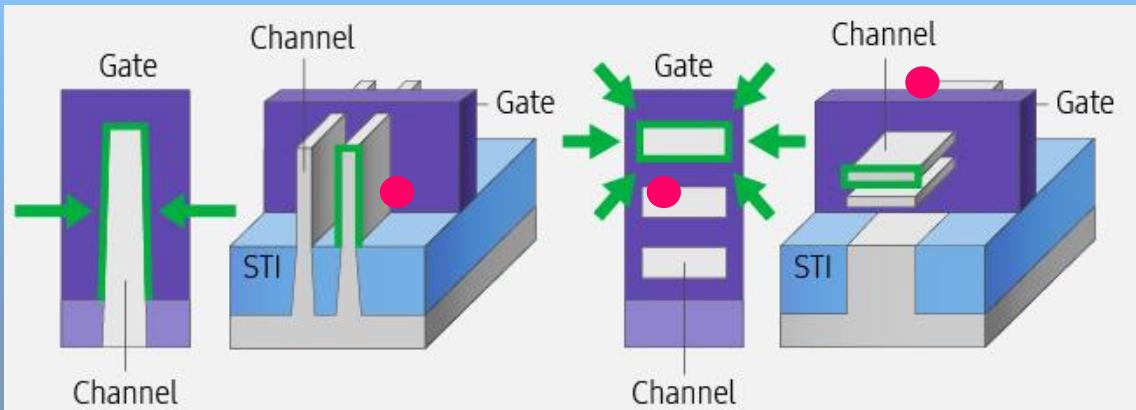


- Moore’s Law continues to drive into **2 nm technology node** using gate-all-around (**GAA**)
- GAA metrology **challenges**: **size shrinkage**, **new materials**, 3D complex structure, and **atomic resolution** ( $\leq 0.1 \text{ nm}$ ) for more than 30 key parameters

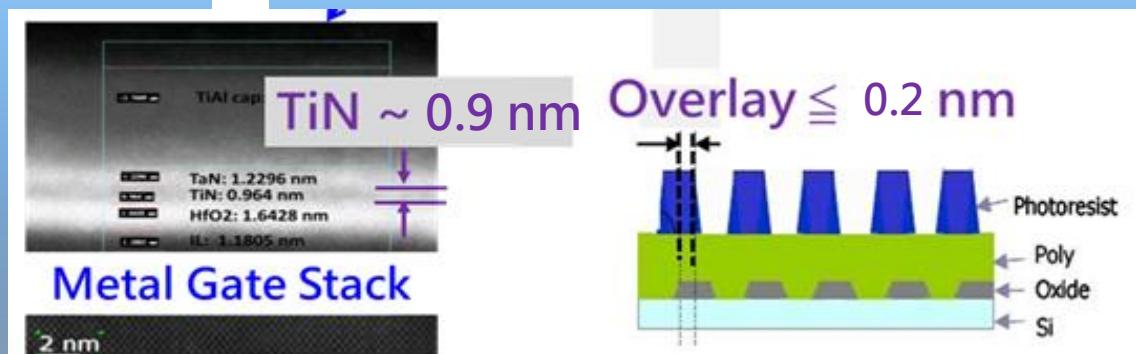
# Two Key Directions for Semiconductor Standards

## Nanocscale CD Metrology

CDs: 3D profiles for FinFET and GAA

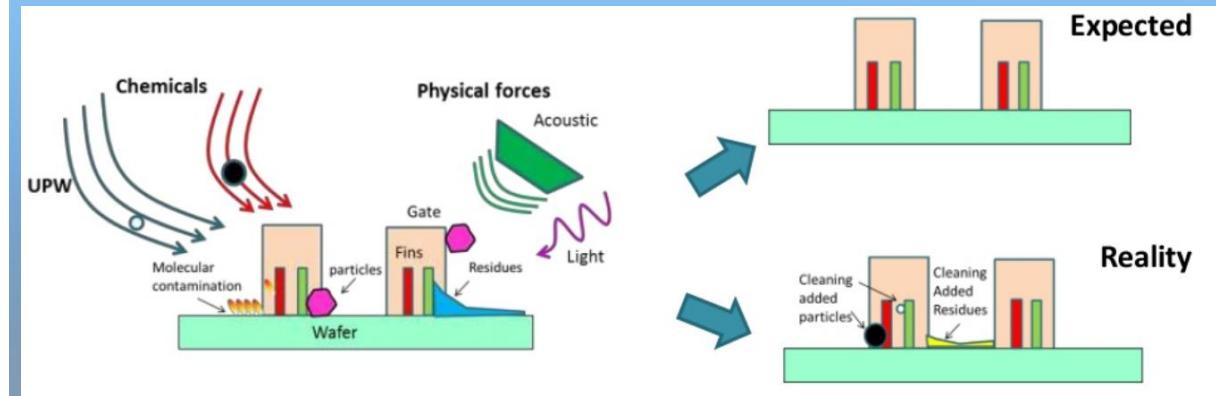


## Film thickness, Overlay



## Nanoparticle Metrology

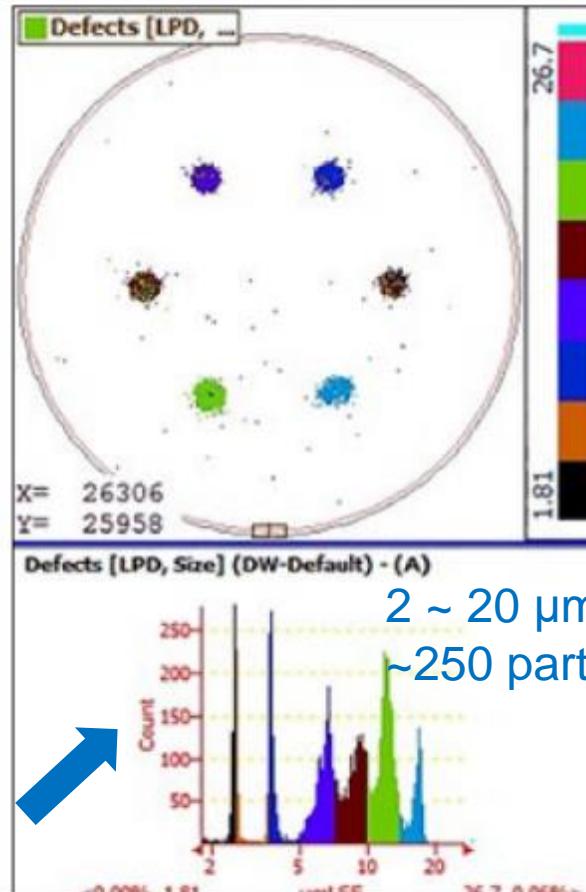
Particle and Impurity



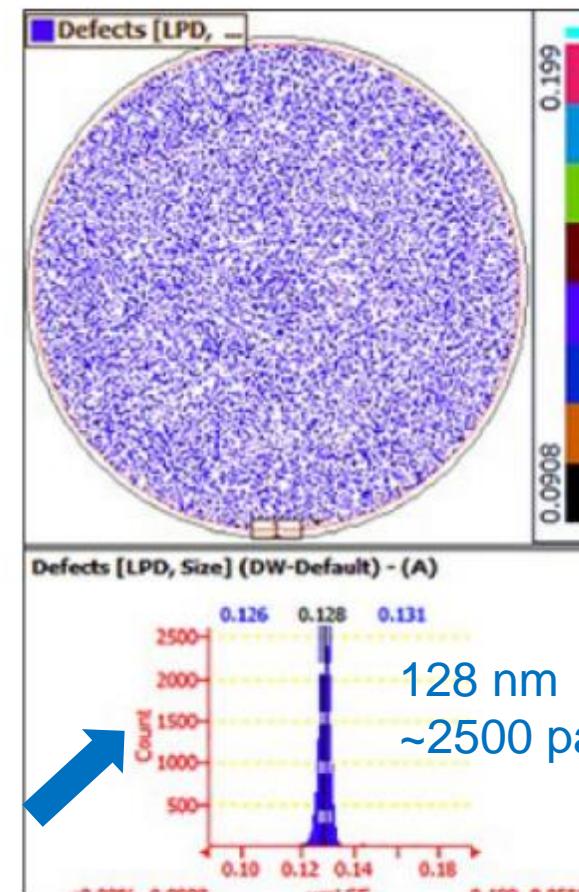
Parameter	Spec.
Metal pitch	20.0 nm
Gate width	7.0 nm
Film thickness	≤ 0.9 nm
Overlay	≤ 0.2 nm
Particle and Impurity	Size < 20 nm Number < 10 <sup>4</sup> #/mL Composition

# On Wafer Particle Defect Inspections

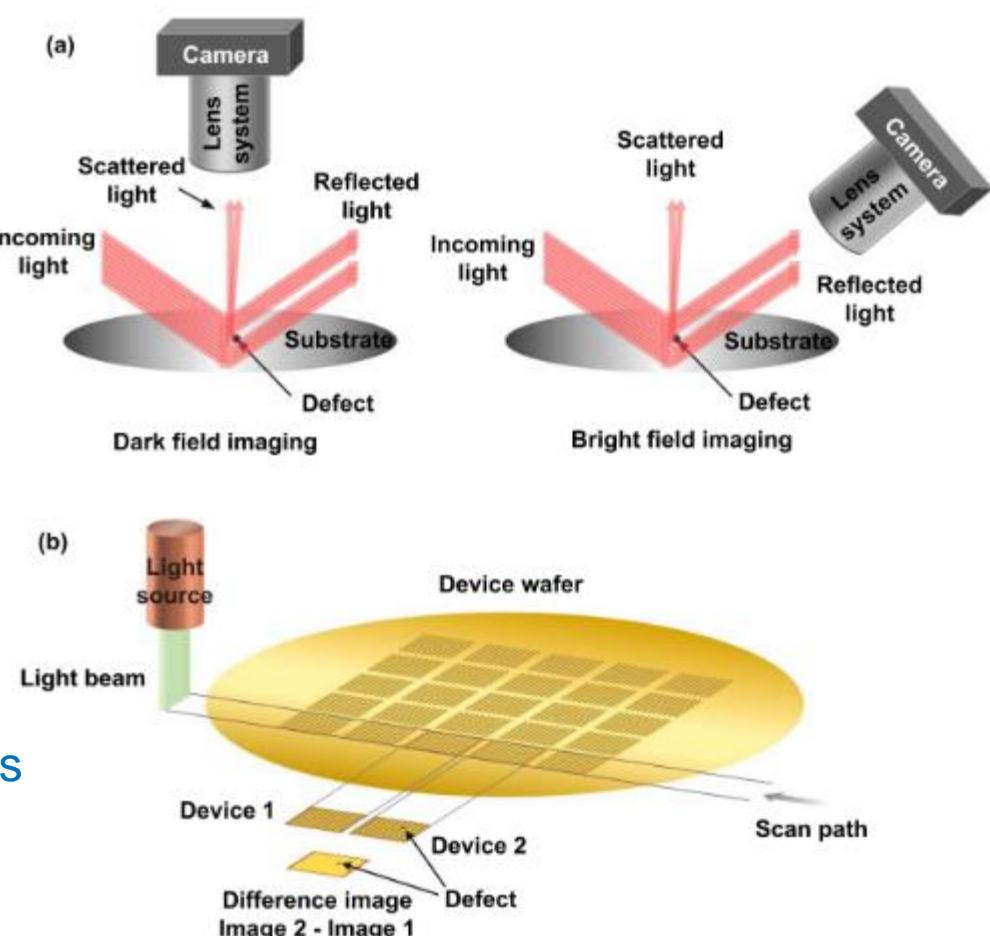
## ➤ Calibrated particles deposited on wafer



Spot deposits of PSL spheres (2-20  $\mu\text{m}$ )



Full deposit of PSL spheres (modal diameter: 128 nm)

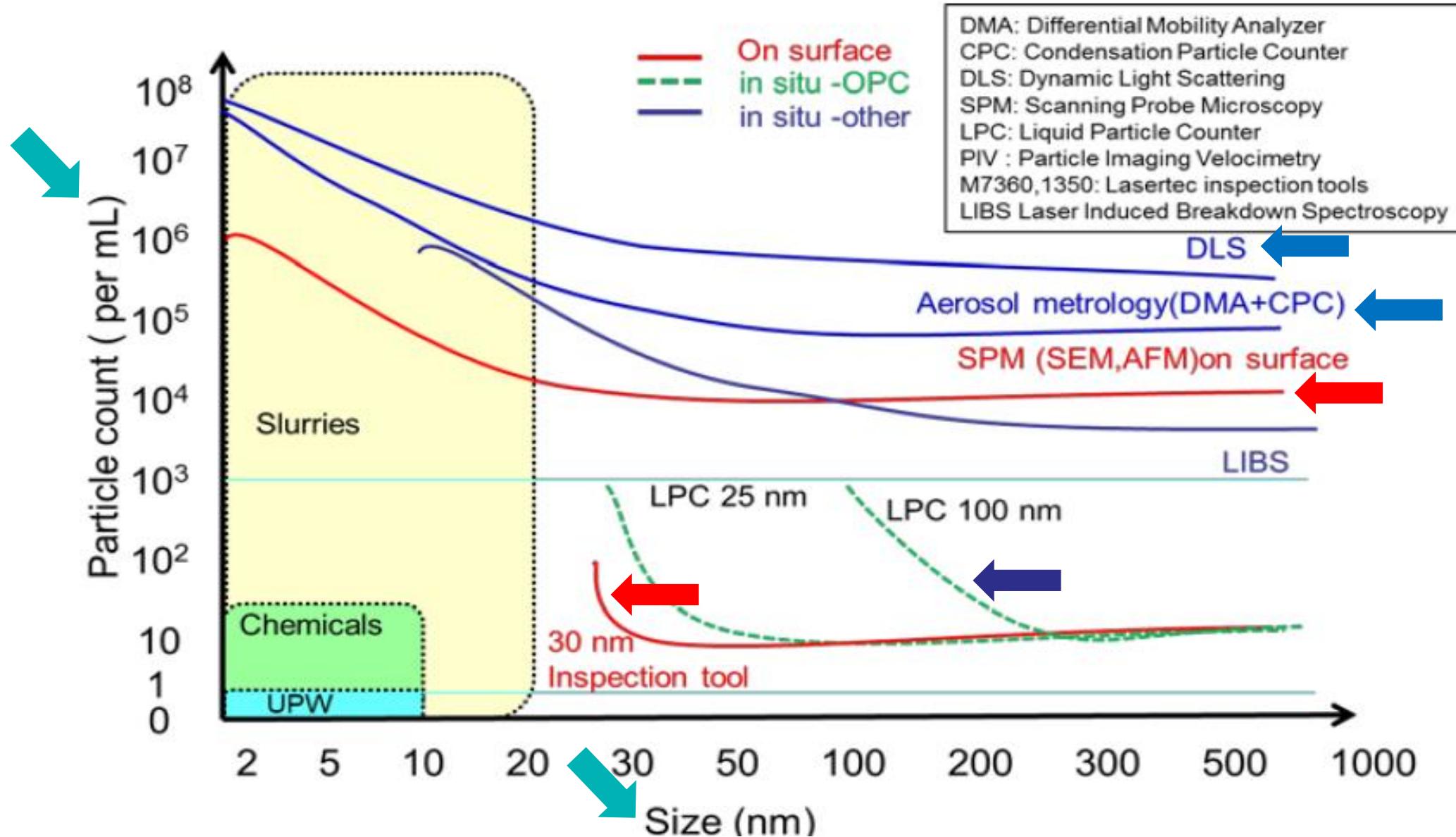


Optical wafer defect inspection at the 10 nm technology node and beyond,  
Zhu et al, 21 April 2022, International Journal of Extreme Manufacturing

## Standards for Particles on Wafer Inspections

MSP ([www.mspcorp.com](http://www.mspcorp.com)), a division of TSI Cooperated.

# Metrology Challenges for Nanoparticles



**Metrology requirement for particles**, International Technology Roadmap for Semiconductors, 2017.

# APMP.L-S5, 2012



**APMP.L-S5, 2012**

**Length, Dimensional Metrology, Nano particles measurements  
Joint Comparison with TCMM in APMP**



Pilot laboratories	CMS/ITRI, NMIJ
Participants	CENAM, CMS, DFM, INMETRO, INRIM, KRISS, LNE, METAS, NIM, NIMT, NMIA, NMISA, NMIJ, PTB
Methods	AFM, SEM, TEM, DLS, DMA, XRD, SAXS

No.	Material	Nominal size [nm]	Volume [mL]	Number concentration [particles/mL] <sup>1</sup>	Manufacturer
G1	Nano Gold	10	2	$5.7 \times 10^{12}$	BBInternational
S2	Nano Silver	20	2	$4.0 \times 10^{11}$	nanoComposix
P3	Polystyrene latex	30	1	$7.0 \times 10^{14}$	JSR
P4	Polystyrene latex	100	1	$1.8 \times 10^{13}$	JSR
P5	Polystyrene latex	300	1	$7.1 \times 10^{11}$	JSR

# Other Than Size and Number Concentration?



3000 Series, 15 mL, 1% Solids	
Diameter	Cat. Number
Aqueous Suspensions, Calibrated by Photon Correlation Spectroscopy (PCS)	
20 nm	3020A
30 nm	3030A
40 nm	3040A
Aqueous Suspensions, Calibrated by Transmission Electron Microscopy (TEM)	
50 nm	3050A
60 nm	3060A
70 nm	3070A
80 nm	3080A
90 nm	3090A
100 nm	3100A
125 nm	3125A
150 nm	3150A
200 nm	3200A
220 nm	3220A
240 nm	3240A
270 nm	3269A
300 nm	3300A
350 nm	3350A
400 nm	3400A
450 nm	3450A
500 nm	3495A
500 nm	3500A
560 nm	3560A
600 nm	3600A
700 nm	3700A
800 nm	3800A
900 nm	3900A

- Size
- Size Distribution
- Number Concentration?
- Materials (Composition)?

# Urgent Requirements for NP

- Reference Standards
  - Sizes of nanoparticles  $\leq 20$  nm
  - Number distribution  $\leq 10^4$  #/mL
- Measurement Technology
  - Sizes of nanoparticles  $\leq 5$  nm
  - Number distribution  $\leq 10$  #/mL
  - In-line calibration

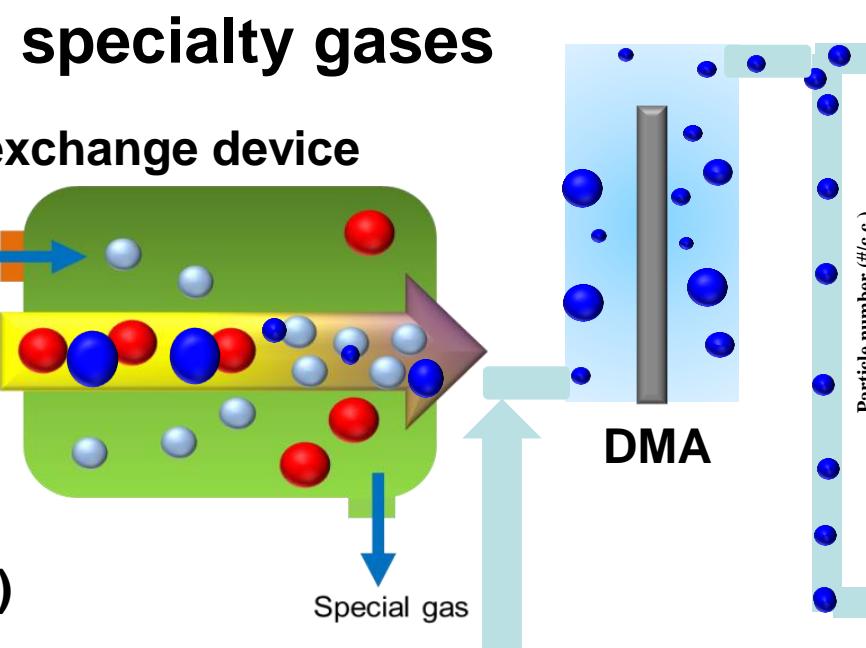
# Nanoparticle Metrology in Front End Processes

## Particle monitoring in specialty gases

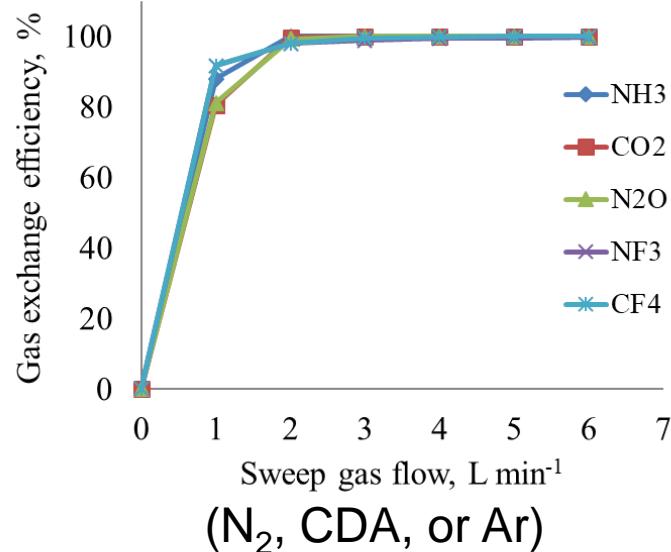


**Gas exchange device**

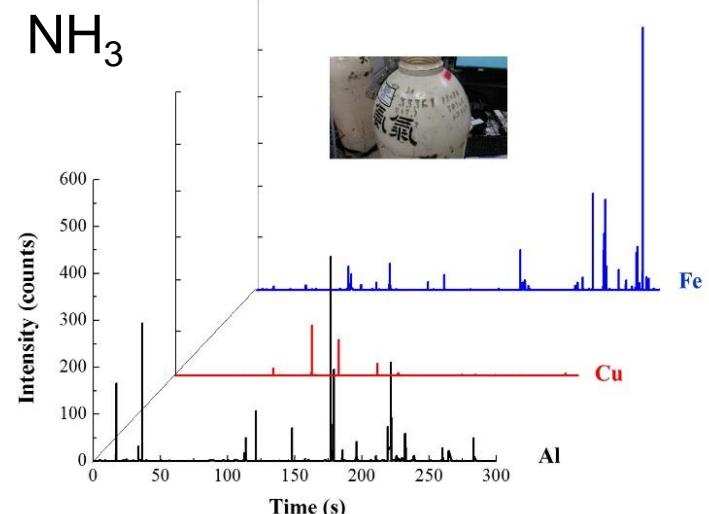
- Sweep gas
- Special gas
- Particle



**Gas exchange device (GED)  
Performance test**

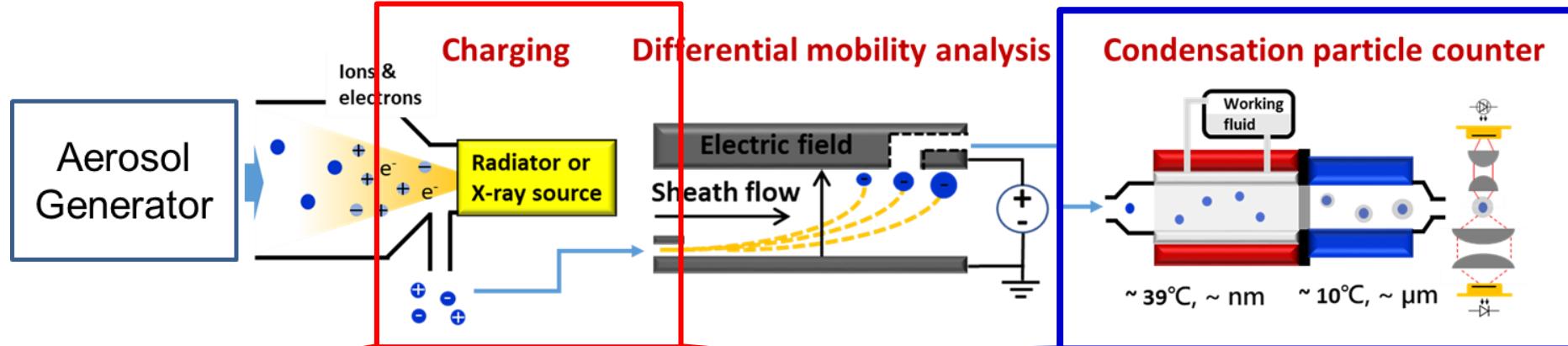


**Composition analysis of different-sized particles**

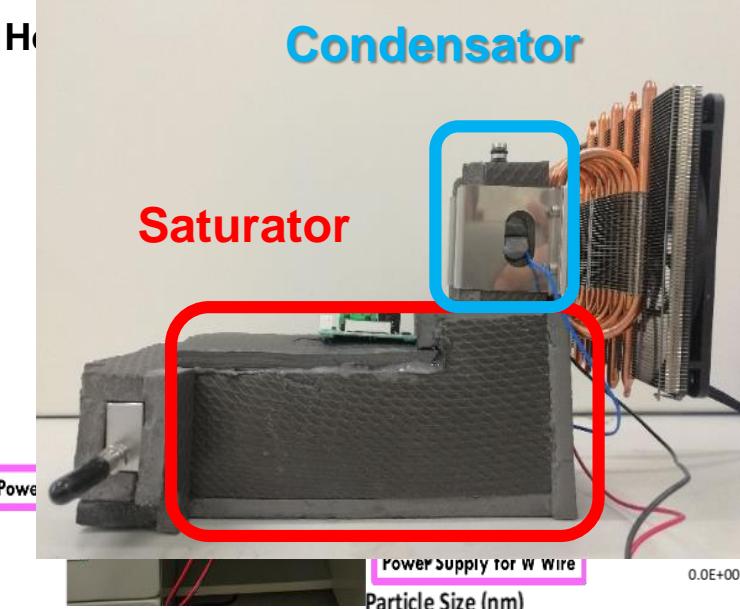


# Particle Monitoring in Ultrapure Reagents

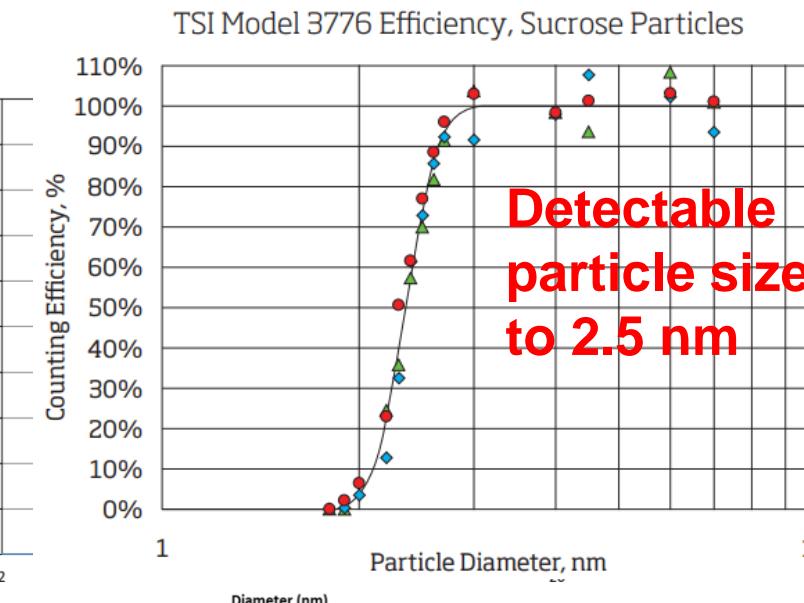
## Performance enhancement of DMA-CPC



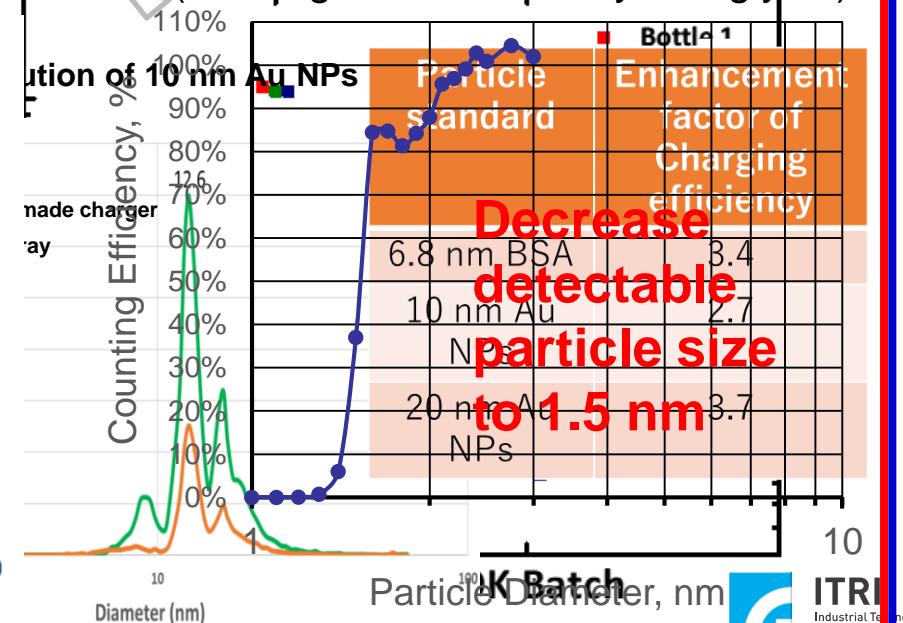
~~Home-made enhancer: Enhance charging efficiency (working solution: butanol)~~



~~Commercial CPC (working solution: butanol)~~



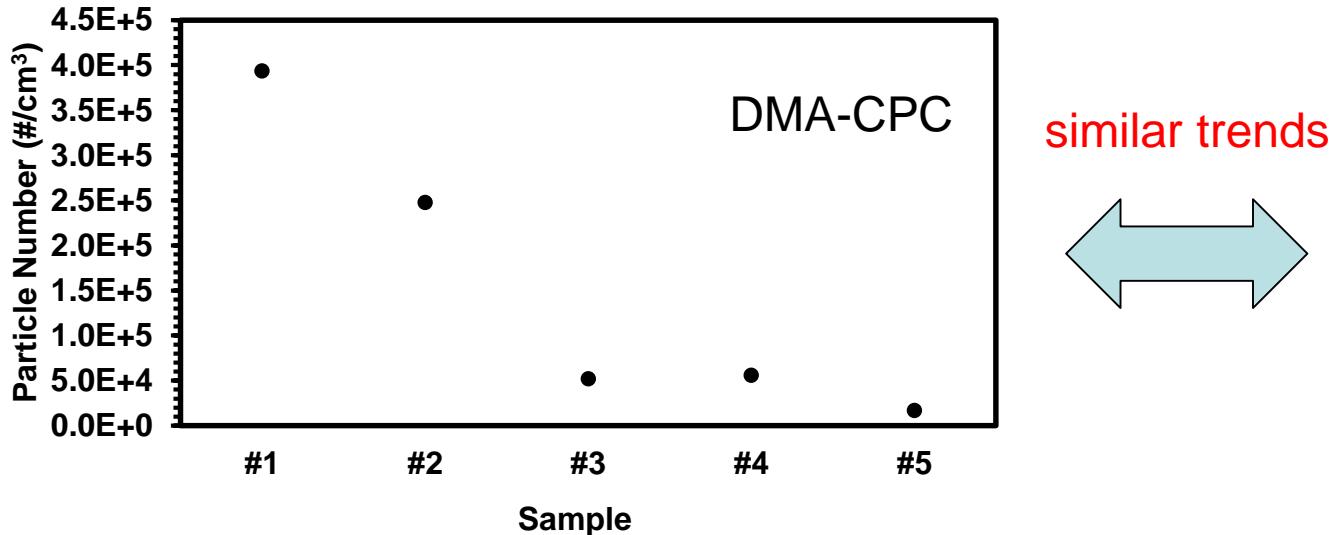
~~Enhancer + CPC efficiency (working solution: Diethylene glycol)~~



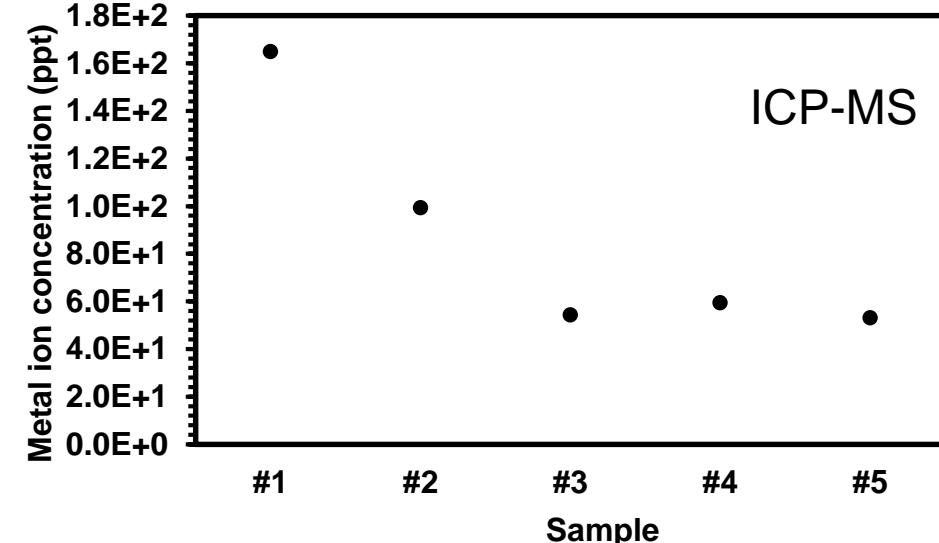
# Particle Monitoring in Ultrapure Reagents

## Complementary information by DMA-CPC and ICP-MS

Particle Number Comparison

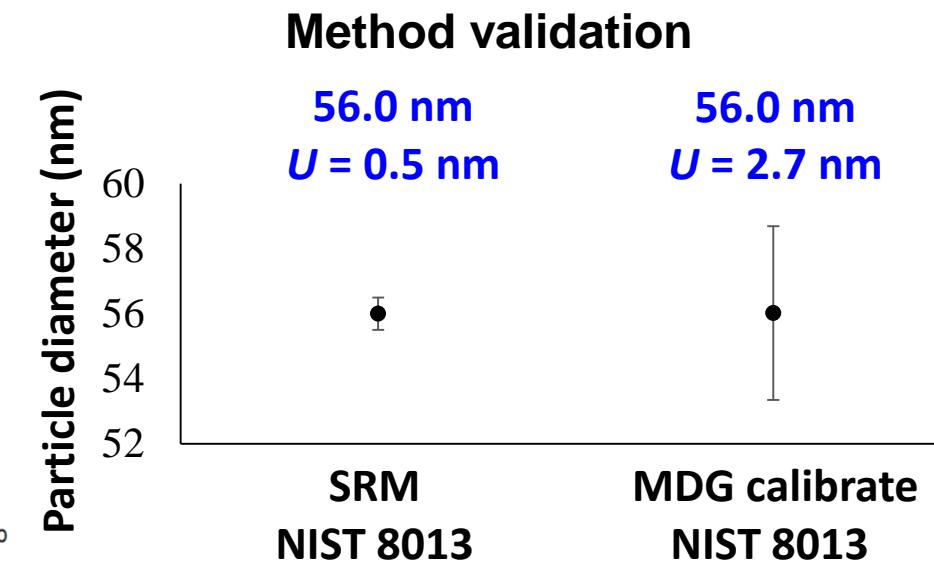
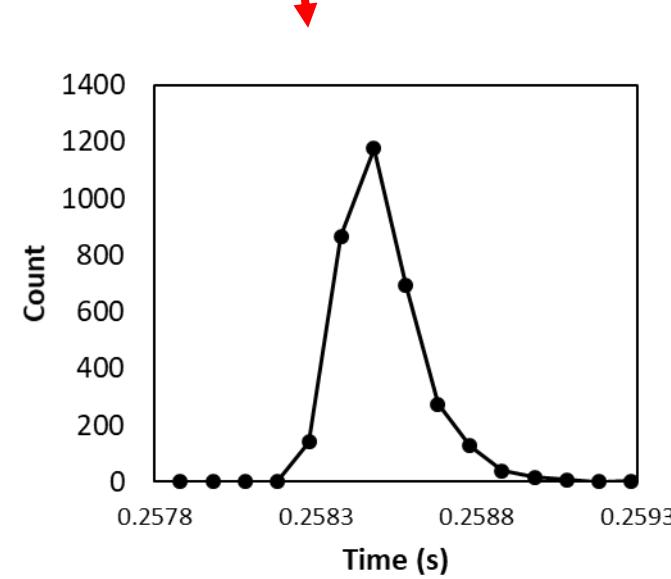
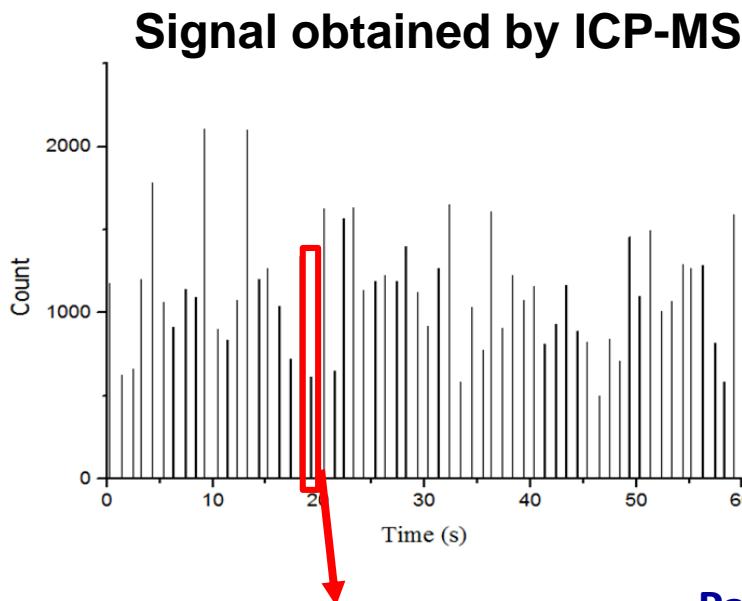
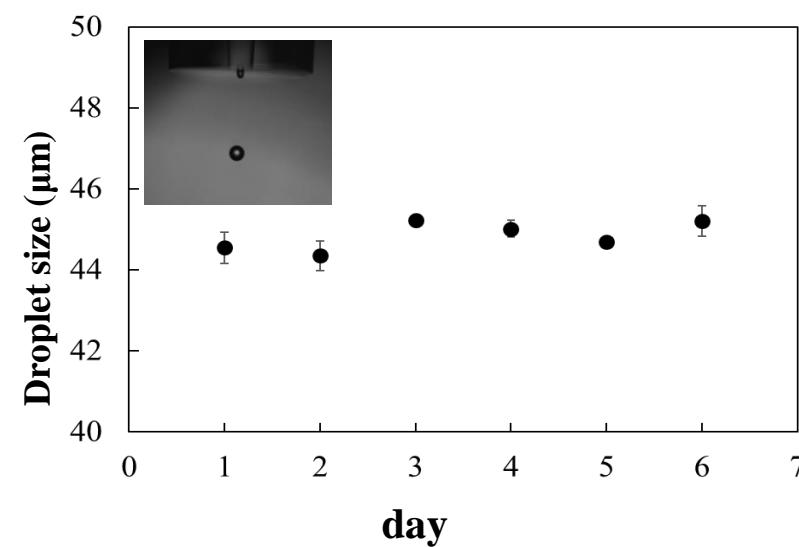
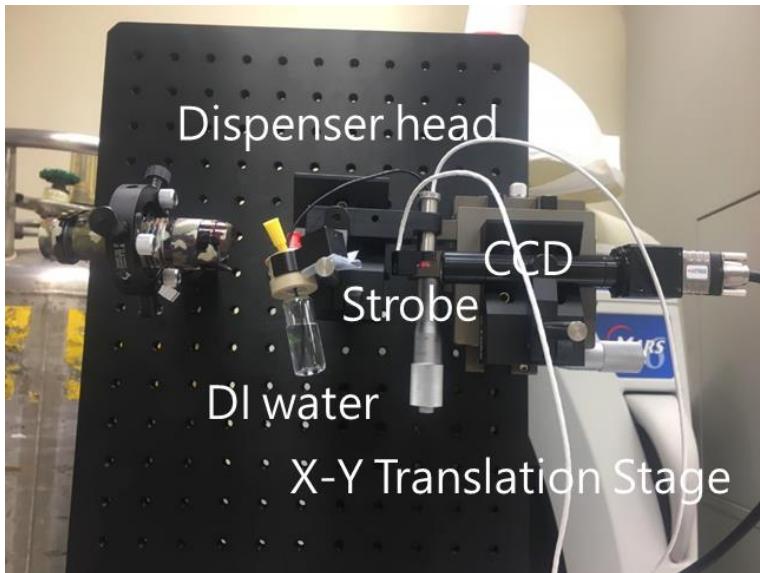


Metal ion Comparison



Bottle	Ag	Al	Ca	Co	Cr	Cu	Fe	K	Li	Mg	Na	Ni	Pb	Total ion (ppt)
#1	10.6	1.9	5.2	1.2	13.8	15.6	67.1	1.9	0.1	1.4	37.9	7.6	0.7	164.9
#2	15.4	5.9	0.4	0.3	2.3	19.1	15.0	3.6	0.1	0.4	34.0	1.5	1.4	99.3
#3	9.8	0.4	1.1	0.1	1.9	7.2	2.7	1.4	0.2	0.3	27.3	0.8	1.1	54.3
#4	11.5	0.5	1.8	0.2	1.7	5.8	4.9	2.4	0.1	0.2	28.5	1.1	0.7	59.4
#5	14.7	4.5	0.1	0.1	1.5	1.8	1.1	1.4	0.2	0.2	26.6	0.2	0.7	53.1

# splICP-MS calibration by MDG



Particle equivalent diameter

$$D = \sqrt[3]{\frac{(48.8 \mu\text{m})^3 * 35.91 \text{ ng/cm}^3}{19.32 \text{ g/cm}^3}} = 60.0 \text{ nm}$$

Symbol	Meaning
$D$	Particle equivalent diameter(nm)
$\rho$	Particle density(g/cm <sup>3</sup> )
$R$	Droplet diameter(μm)
$C_a$	Metal ion concentration (ng/cm <sup>3</sup> )

$$U_D = 2.1 \text{ nm}$$

# SEMI Inspection and Metrology Committee

## SEMI- Semiconductor Equipment and Materials International



The banner features the text "SEMI Taiwan Inspection & Metrology Committee 2021" in large white letters on a green background. Below it, the date "March 24<sup>th</sup>, 2021" and the location "Semiconductor Equipment and Materials International" are mentioned. A yellow arrow points from the text "Semiconductor Equipment and Materials International" towards the list of missions.

**WG1: Purity And Particle Analysis for Semiconductor Raw Materials**

**WG2: Advanced IC Package measurement & metrology technology**

**semi** CONNECT - COLLABORATE - INNOVATE

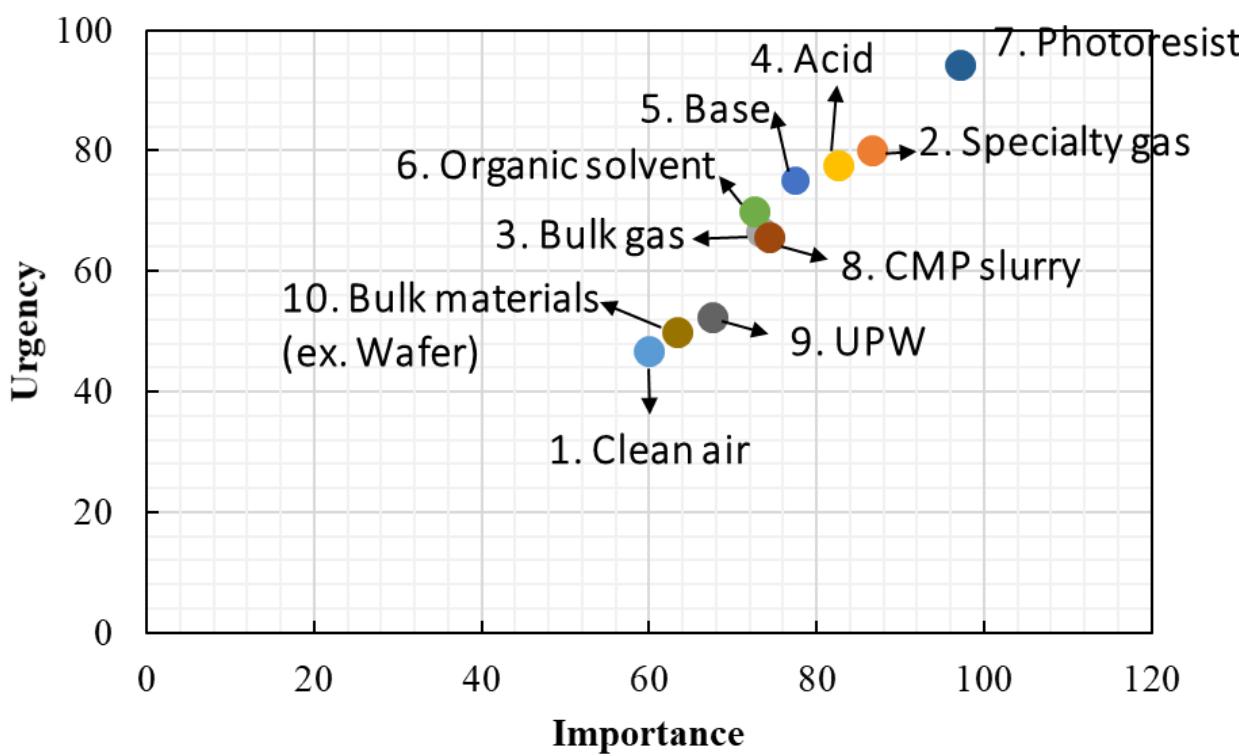
- **Missions**

- To develop innovative **measurement** technique/method for determination of
  - ✓ Particle (size/number/composition)
  - ✓ Anion/cation
  - ✓ Organic (TOC/speciation)
- To build a Correlation between on-line and off-line inspection tool
- To provide strategic advices in overcoming purity analysis problem
- To establish cooperation among research institute, vendor, and end users

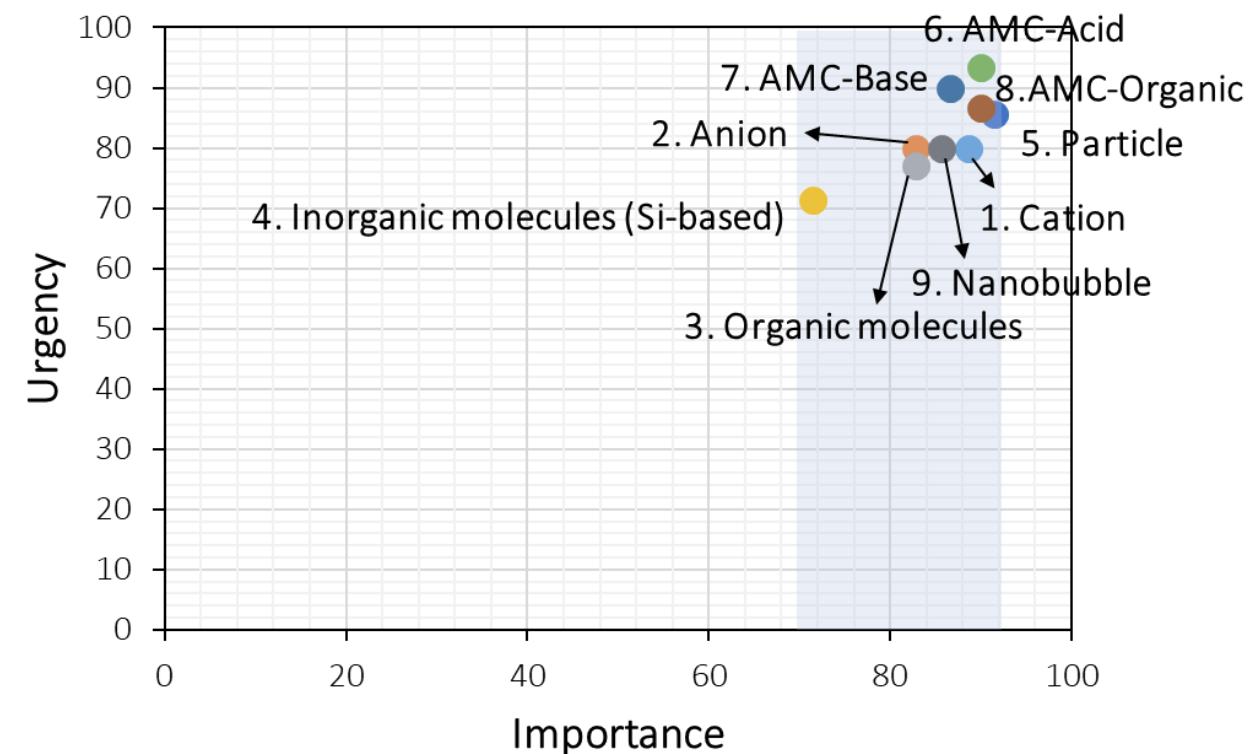
# Preliminary Survey for Nanoparticle Metrology

- Questionnaire for Needs in Purity and particle analysis for semiconductor raw materials

**A. Raw material**



**B. Impurity type**



# Summary

- Raw materials
  - Top 3 importance: Photoresist, specialty gas, acid
  - Top 3 urgency: Photoresist, base, acid
- Impurity type
  - Top 3 importance: Particle, cation, AMC-base
  - Top 3 urgency: Particle, cation, AMC-base
- Analytical method
  - Meet expectation: cation, inorganic, AMC,
  - Not meet expectation: anion, organic molecule, Particle, nanobubbles

# Summary

- CMS/ITRI have established the measurement technology for size, number, and composition analysis of nanoparticles, particularly for Ultra-Fine Particles/Impurities monitoring in process gases and chemicals.
- CMS/ITRI have demonstrated the possibility of DMA-CPC for AMC monitoring by converting the gas molecule to particle.

# Acknowledgements

- Nanoparticle Group

1. Dr. Fan-hsin Lin
2. Dr. Ching-Hsuan Chang
3. Ta-Chang Yu
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8. Yi-Hsuan Pan
9. Chia-Yun Tsao
10. Shu-Han Hung

